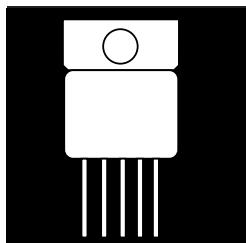


## DUAL MOSFETS IN 5 PIN HERMETIC SIP PACKAGE, N & P CHANNEL



**Complementary 100V N-Channel And P-Channel Power MOSFETs In 5 Pin Hermetic SIP Package**

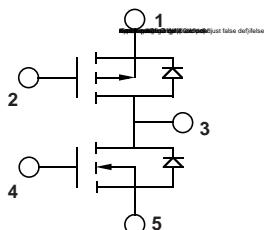
### FEATURES

- Low  $R_{DS(on)}$
- Fast Switching
- Easy To Heat Sink
- Small Isolated Hermetic Package
- Available Hi-Rel Screened To MIL-S-19500, TX, TXV And S Levels

### DESCRIPTION

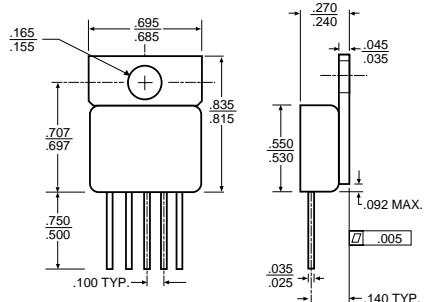
This series of hermetically packaged products feature the latest advanced MOSFET and packaging technology. They are ideally suited for Hi-Rel requirements where small size, high performance and high reliability are required, and in applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers and high energy pulse circuits.

### SCHEMATIC

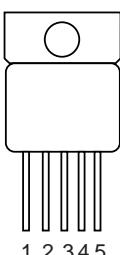


3.1

### MECHANICAL OUTLINE



### PIN CONNECTION



- 1 Pch Source
- 2 Pch Gate
- 3 Output
- 4 Nch Gate
- 5 Nch Source

**ELECTRICAL CHARACTERISTICS:  $T_C = 25^\circ$  unless otherwise noted**  
**STATIC N Channel (100V)**

Parameter	Min.	Typ.	Max.	Units	Test Conditions
$BV_{DSS}$ Drain-Source Breakdown Voltage	100			V	$V_{GS} = 0$ , $I_D = 250 \text{ mA}$
$V_{GS(th)}$ Gate-Threshold Voltage	2.0	4.0	V		$V_{DS} = V_{GS}$ , $I_D = 250 \text{ mA}$
$I_{GSS}$ Gate-Body Leakage Forward		$\pm 100$	nA		$V_{GS} = \pm 20 \text{ V}$
$I_{DSS}$ Zero Gate Voltage Drain Current		0.25 1.0	mA		$V_{DS} = \text{Max. Rat.}, V_{GS} = 0$ $V_{DS} = 0.8 \text{ Max. Rat.}, V_{GS} = 0$ , $T_C = 125^\circ \text{ C}$
$V_{DS(on)}$ Static Drain-Source On-State Voltage <sup>1</sup>		1.425	V		$V_{GS} = 10 \text{ V}$ , $I_D = 15 \text{ A}$
$R_{DS(on)}$ Static Drain-Source On-State Resistance <sup>1</sup>		.115			$V_{GS} = 10 \text{ V}$ , $I_D = 15 \text{ A}$
$R_{DS(on)}$ Static Drain-Source On-State Resistance <sup>1</sup>		.20			$V_{GS} = 10 \text{ V}$ , $I_D = 15 \text{ A}$ , $T_C = 125 \text{ C}$

**ELECTRICAL CHARACTERISTICS:  $T_C = 25^\circ$  unless otherwise noted**  
**STATIC P Channel (100V)**

Parameter	Min.	Typ.	Max.	Units	Test Conditions
$BV_{DSS}$ Drain-Source Breakdown Voltage	100			V	$V_{GS} = 0$ , $I_D = 250 \text{ mA}$
$V_{GS(th)}$ Gate-Threshold Voltage	2.0	4.5	V		$V_{DS} = V_{GS}$ , $I_D = 250 \text{ mA}$
$I_{GSS}$ Gate-Body Leakage Forward		$\pm 100$	nA		$V_{GS} = \pm 20 \text{ V}$
$I_{DSS}$ Zero Gate Voltage Drain Current		.01 .10	mA		$V_{DS} = \text{Max. Rat.}, V_{GS} = 0$ $V_{DS} = 0.8 \text{ Max. Rat.}, V_{GS} = 0$ , $T_C = 125^\circ \text{ C}$
$V_{DS(on)}$ Static Drain-Source On-State Voltage <sup>1</sup>		4.2	V		$V_{GS} = 10 \text{ V}$ , $I_D = 20 \text{ A}$
$R_{DS(on)}$ Static Drain-Source On-State Resistance <sup>1</sup>		0.20			$V_{GS} = 10 \text{ V}$ , $I_D = 10 \text{ A}$
$R_{DS(on)}$ Static Drain-Source On-State Resistance <sup>1</sup>		0.40			$V_{GS} = 10 \text{ V}$ , $I_D = 10 \text{ A}$ , $T_C = 125 \text{ C}$

**DYNAMIC**

$g_{fs}$	Forward Transductance <sup>1</sup>	10		S (M)	$V_{DS} = 2 V_{DS(on)}$ , $I_D = 15 \text{ A}$
$C_{iss}$	Input Capacitance	1275		pF	$V_{GS} = 0$
$C_{oss}$	Output Capacitance	550		pF	$V_{DS} = 25 \text{ V}$
$C_{rss}$	Reverse Transfer Capacitance	160		pF	f = 1 MHz
$T_{d(on)}$	Turn-On Delay Time	16	ns		$V_{DD} = 50 \text{ V}$ , $I_D @ 5 \text{ A}$
$t_r$	Rise Time	19	ns		$R_g = 50 \text{ W}$ , $V_{GS} = 10 \text{ V}$
$T_{d(off)}$	Turn-Off Delay Time	42	ns		(MOSFET) switching times are essentially independent of operating temperature.
$t_f$	Fall Time	24	ns		

**DYNAMIC**

$g_{fs}$	Forward Transductance <sup>1</sup>	5.0		S (M)	$V_{DS} = 2 V_{DS(on)}$ , $I_D = 10 \text{ A}$
$C_{iss}$	Input Capacitance	1700		pF	$V_{GS} = 0$
$C_{oss}$	Output Capacitance	760		pF	$V_{DS} = 25 \text{ V}$
$C_{rss}$	Reverse Transfer Capacitance	320		pF	f = 1 MHz
$T_{d(on)}$	Turn-On Delay Time	36	ns		$V_{DD} = 25 \text{ V}$ , $I_D @ 10 \text{ A}$
$t_r$	Rise Time	160	ns		$R_g = 50 \text{ W}$ , $V_{GS} = 10 \text{ V}$
$T_{d(off)}$	Turn-Off Delay Time	120	ns		(MOSFET) switching times are essentially independent of operating temperature.
$t_f$	Fall Time	120	ns		

**BODY-DRAIN DIODE RATINGS AND CHARACTERISTICS**

$I_S$	Continuous Source Current (Body Diode)		- 27	A	Modified MOSPOWER symbol showing the integral P-N Junction rectifier.
$I_{SM}$	Source Current <sup>1</sup> (Body Diode)		- 108	A	
$V_{SD}$	Diode Forward Voltage <sup>1</sup>		- 2.0	V	$T_C = 25^\circ \text{ C}$ , $I_S = -24 \text{ A}$ , $V_{GS} = 0$
$t_{rr}$	Reverse Recovery Time	400	ns		$T_J = 150^\circ \text{ C}$ , $I_F = I_S$ , $dI_F/dt = 100 \text{ A/ms}$

**BODY-DRAIN DIODE RATINGS AND CHARACTERISTICS**

$I_S$	Continuous Source Current (Body Diode)		20	A	Modified MOSPOWER symbol showing the integral P-N Junction rectifier.
$I_{SM}$	Source Current <sup>1</sup> (Body Diode)		80	A	
$V_{SD}$	Diode Forward Voltage <sup>1</sup>		4.0	V	$T_C = 25^\circ \text{ C}$ , $I_S = 20 \text{ A}$ , $V_{GS} = 0$
$t_{rr}$	Reverse Recovery Time		4.75	ns	$I_F = 20 \text{ A}$ , $dI_F/dt = 100 \text{ A/ms}$

**1 Pulse Test:** Pulse Width 300msec, Duty Cycle 2%.**1 Pulse Test:** Pulse Width 300msec, Duty Cycle 2%.

For Absolute Maximum Ratings see OMY140.

For Absolute Maximum Ratings see OM20P10ST.